



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
30V	1.5Ω @ V <sub>GS</sub> = 4.5V	
	2.0Ω @ V <sub>GS</sub> = 2.5V	0.004
	3.0Ω @ V <sub>GS</sub> = 1.8V	0.22A
	4.5Ω @ V <sub>GS</sub> = 1.5V	

### **Description**

This MOSFET has been designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- General Purpose Interfacing Switch
- Power Management Functions
- **Analog Switch**

## **Features and Benefits**

- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V Max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 1mm x 1mm
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

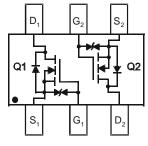
- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.027 grams (Approximate)



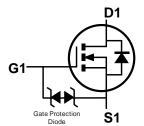




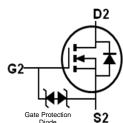
Top View



Top View Pin out



Q1 N-CHANNEL



**Q2 N-CHANNEL** 

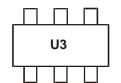
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN31D5UDJ-7	SOT963	10k/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



U3 = Product Type Marking Code

DMN31D5UDJ Document number: DS39629 Rev. 2 - 2

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## Maximum Ratings N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	220 160	mA
Maximum Continuous Body Diode Forward Current (Note 6)			I <sub>S</sub>	200	mA
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	600	mA

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

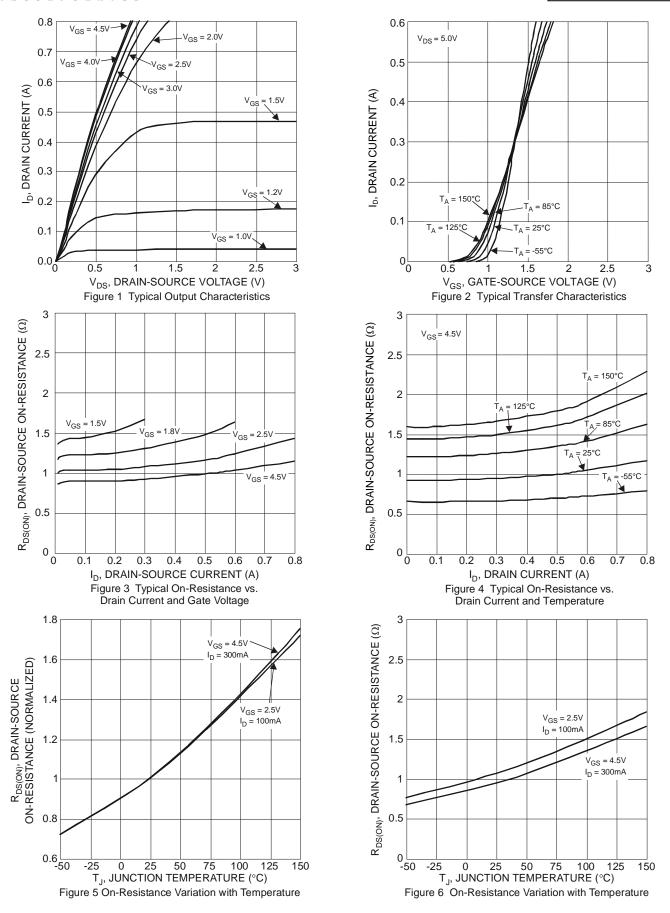
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	$P_D$	350	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	361	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	; I <sub>DSS</sub>	1	_	100	nA	$V_{DS} = 24V$ , $V_{GS} = 0V$	
Gate-Source Leakage			_	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
			0.9	1.5	Ω	$V_{GS} = 4.5V, I_D = 100mA$	
Static Drain-Source On-Resistance	D	1	1.0	2.0		$V_{GS} = 2.5V, I_D = 50mA$	
Static Dialii-Source On-Resistance	R <sub>DS(ON)</sub>	_	1.2	3.0		$V_{GS} = 1.8V, I_D = 20mA$	
		1	1.4	4.5		$V_{GS} = 1.5V, I_D = 10mA$	
Diode Forward Voltage			0.6	1.0	V	$V_{GS} = 0V, I_{S} = 10mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance		1	22.6	_	pF		
Output Capacitance			2.68	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		1.8	_	pF	11 = 1.0IVIFIZ	
Total Gate Charge	$Q_g$		0.38	_	nC		
Gate-Source Charge		_	0.05	_	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$ $I_{D} = 200 \text{mA}$	
Gate-Drain Charge	$Q_{gd}$	_	0.07	_	nC	ID = ZUUIIA	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.2	_	ns		
Turn-On Rise Time Turn-Off Delay Time		_	2.2	_	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$	
		_	21	_	ns	$R_G = 2\Omega$ , $I_D = 200mA$	
Turn-Off Fall Time	t <sub>F</sub>	_	7.5	_	ns	<u> </u>	

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
  6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
  7. Short duration pulse test used to minimize self-heating effect.
  8. Guaranteed by design. Not subject to product testing.







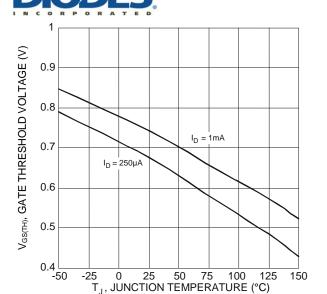
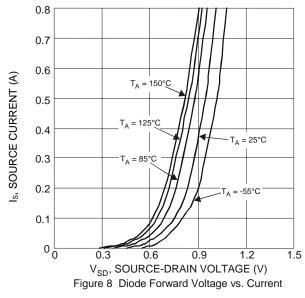
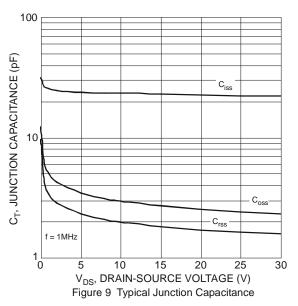
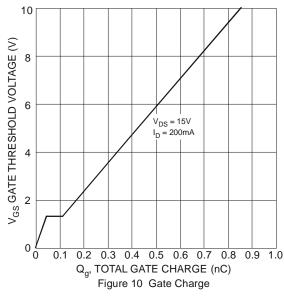
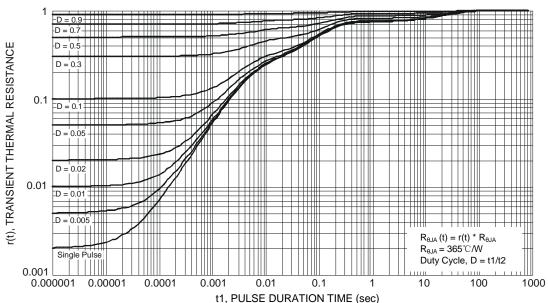


Figure 7 Gate Threshold Variation vs. Junction Temperature







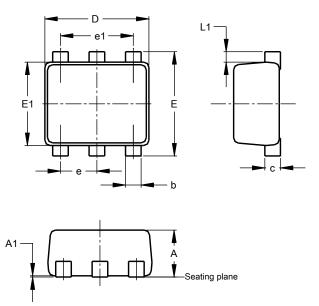




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT963

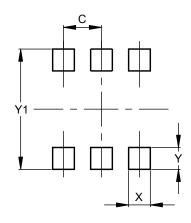


SOT963					
Dim	Min	Max	Тур		
Α	0.40	0.50	0.45		
A1	0.00	0.05			
b	0.10	0.20	0.15		
С	0.120	0.180	0.150		
D	0.95	1.05	1.00		
Е	0.95	1.05	1.00		
E1	0.75	0.85	0.80		
е			0.35		
e1			0.70		
L1	0.05	0.15	0.10		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT963



Dimensions	Value		
Dilliensions	(in mm)		
С	0.350		
Х	0.200		
Y	0.200		
V1	1 100		



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